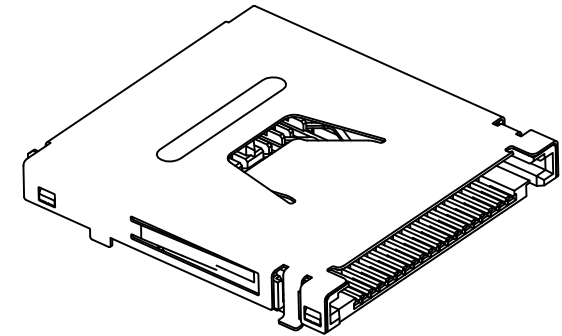



NOTES :

1. MATERIAL :  
 INSULATOR : HIGH TEMPERATURE THERMOPLASTIC , UL94V-0.  
 COLOR : BLACK  
 CONTACT : PHOSPHOR BRONZE.
2. APPLICATION : SD&HS SD&SDHC&MMC & MS&MS PRO&MagicGate MS&MS-ROM&MS I/O Expansion (It can protect the damage of MSDuo)
3. PLATING : CONTACT AREA :GOLD FLASH,10u" PLATED OVER Ni  
 SOLDER AREA : Tin PLATED OVER Ni

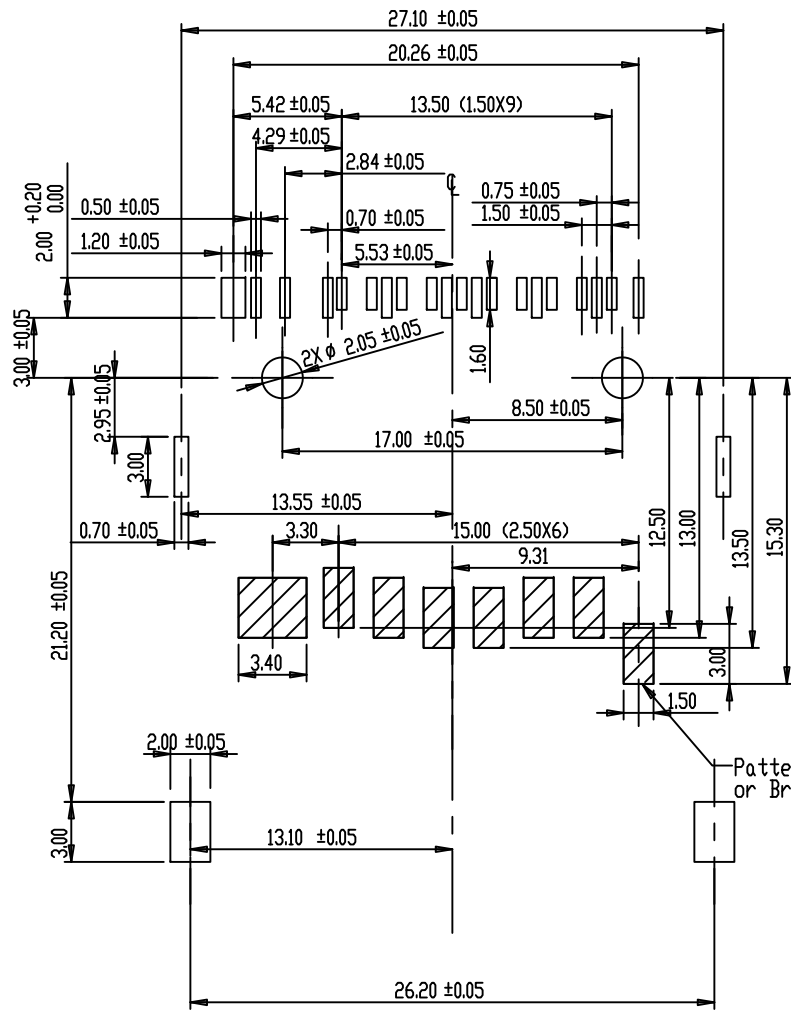
107R-A X 0 0-R  
 1 2 3

- 1.Type  
 A:SD/MMC/MS
- 2.Contact Plating  
 A:Gold Flash  
 D:10u" Gold Plating
- 3.RoHS



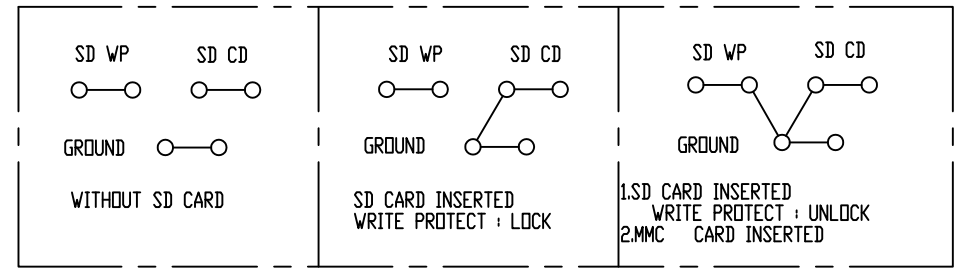
UNLESS OTHERWISE SPECIFIED TOLERANCE		 <b>ATTEND TECHNOLOGY INC.</b> www.attend.com.tw
ANG.	±5°	
0.	±0.3	SCALE: AS SHOWN UNIT: mm DRAWN <b>Willis</b> 2008/4/3 CHECKED / / APPROVED / / FILE NAME: 107R-AX00-R
.0	±0.25	
.00	±0.20	
SCALE:	AS SHOWN	UNIT: mm
DRAWN	Willis	2008/4/3
CHECKED	/ /	
APPROVED	/ /	
REV.		

REV.	DESCRIPTION	DATE
1		
2		
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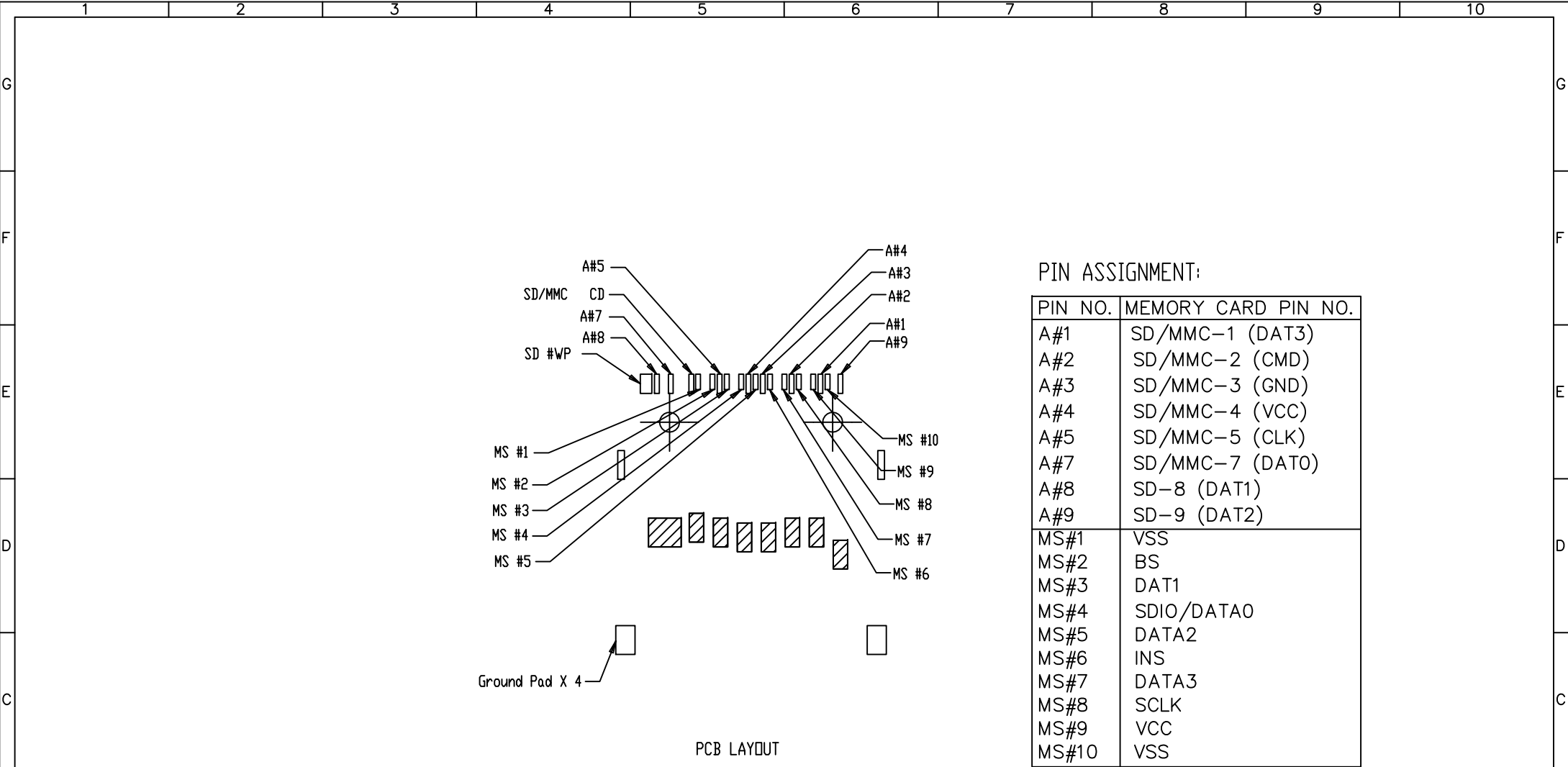
PCB LAYOUT

SD CIRCUIT :



UNLESS OTHERWISE SPECIFIED TOLERANCE		 ATTEND TECHNOLOGY INC. www.attend.com.tw
ANG.	±5°	
0.	±0.3	
.0	±0.25	
.00	±0.20	
SCALE:	AS SHOWN	UNIT: mm
DRAWN	Willis	2008/4/3
CHECKED	/ /	
APPROVED	/ /	
REV.		
DRAWN NAME:		Multi Card Socket SD/MMC/MS
PRODUCT NO.		
FILE NAME:		107R-AX00-R

REV.	DESCRIPTION	DATE	SIZE	REV.
1			A4	



PIN ASSIGNMENT:

PIN NO.	MEMORY CARD PIN NO.
A#1	SD/MMC-1 (DAT3)
A#2	SD/MMC-2 (CMD)
A#3	SD/MMC-3 (GND)
A#4	SD/MMC-4 (VCC)
A#5	SD/MMC-5 (CLK)
A#7	SD/MMC-7 (DAT0)
A#8	SD-8 (DAT1)
A#9	SD-9 (DAT2)
MS#1	VSS
MS#2	BS
MS#3	DAT1
MS#4	SDIO/DATA0
MS#5	DATA2
MS#6	INS
MS#7	DATA3
MS#8	SCLK
MS#9	VCC
MS#10	VSS

( SD/MMC : SD&HS SD&SDHC&MMC CARD )  
 (MS : MS&MS PRO&MagicGate MS&MS-ROM&MS I/O Expansion CARD)

UNLESS OTHERWISE SPECIFIED TOLERANCE	
ANG.	±5°
0.	±0.3
.0	±0.25
.00	±0.20
SCALE: AS SHOWN	UNIT: mm
DRAWN Willis	2008/4/3
CHECKED	/ /
APPROVED	/ /
SIZE A4	REV.

**Attend**  
 ATTEND TECHNOLOGY INC.  
 www.attend.com.tw

DRAWN NAME: Multi Card Socket  
 SD/MMC/MS

PRODUCT NO. 107R-AX00-R

FILE NAME: 107R-AX00-R

REV.	DESCRIPTION	DATE
1		
2		
3		
4		
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